

Please Amend Claim 3 as follows:

1. (Original) A surface-mounting type electronic circuit unit comprising:

- a side electrode arranged on a side face;
- a circuit substrate having a wiring pattern arranged on an upper face in a state connected to this side electrode; and
- an electric part connected to said wiring pattern by soldering;

wherein said wiring pattern has a connecting conductor electrically connecting said side electrode and said electric part, and said connecting conductor connecting said electric part arranged in a position very near said side electrode is formed in a bent state.

2. (Original) The surface-mounting type electronic circuit unit according to claim 1, wherein said connecting conductor is formed in the bent state of a zigzag shape.

3. (Currently Amended) A surface-mounting type electronic circuit unit comprising:

- a side electrode arranged on a side face;
- a circuit substrate having a wiring pattern arranged on an upper face in a state connected to this side electrode; and
- an electric part connected to said wiring pattern by soldering;

wherein said wiring pattern has a connecting conductor electrically connecting said side electrode and said electric part, and a silk layer fabricated by silk screen printing is formed on said connecting conductor connecting said electric part arranged in a position very near said side electrode so as to cross this connecting conductor.

4. (Original) The surface-mounting type electronic circuit unit according to claim 3, wherein said connecting conductor is formed in a straight line shape.

5. (Original) The surface-mounting type electronic circuit unit according to claim 3, wherein said connecting conductor is formed in a bent state.

6. (Original) The surface-mounting type electronic circuit unit according to claim 5, wherein said connecting conductor is formed in the bent state of a zigzag shape.